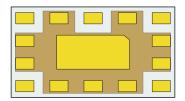
ACFM-7037

Band 3/Band 7 Quadplexer

Product Brief





Description

The Avago Technologies' ACFM-7037 is a quadplexer that combines Band 3 and Band 7 duplexers into a single, miniature package.

The ACFM-7037 features a single antenna connection, which eliminates the need for antenna switching. All ports are matched to 50 ohms.

The ACFM-7037 is designed with Avago Technologies' film bulk acoustic resonator (FBAR) technology. The ACFM-7037 also utilizes Avago Technologies' innovative microcap bonded-wafer, chip scale packaging technology. This process allows the filters to be assembled in a module with a footprint of only $3.6 \, \text{mm} \times 2 \, \text{mm}$ with a maximum height of $0.80 \, \text{mm}$.

Low Tx insertion loss of the ACFM-7037 reduces power amplifier current, which extends battery life. The ACFM-7037 enhances receiver sensitivity and dynamic range with low Rx insertion loss and high rejection of Tx signals at the Rx ports.

The excellent power handling capability of Avago Technologies' FBAR bulk-mode resonators supports the high Tx output power levels needed mobile communications devices while adding virtually no distortion.

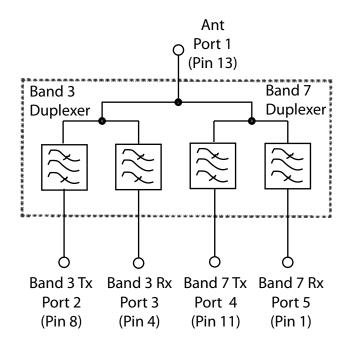
Features

- Single antenna
- Band 3 and Band 7 carrier aggregation
- Miniature size
 - 3.6 mm \times 2 mm footprint
 - 0.80 mm maximum height
- High power rating
 - +31 dBm maximum Tx power
- Environmental
 - RoHS 6 compliant
 - Halogen free
 - TBBPA free

Applications

Smartphones, tablets, and mobile/portable communications devices operating in Bands 3 and 7.

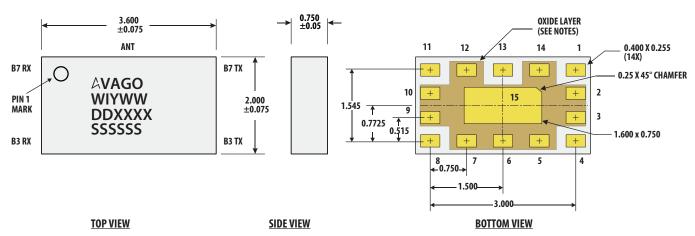
Functional Block Diagram



Ordering Information

Part Number	Number of Devices	Container
ACFM-7037-BLK	100	Tape strip or gel-pack
ACFM-7037-TR1	3000	178 mm (7-inch) reel

Package Dimensions and Marking Specification



Notes:

- 1. Dimensions in millimeters
- 2. Tolerance, unless otherwise noted: $\begin{array}{c} \text{X.XX} \pm 0.05 \text{ mm} \\ \text{X.XXX} \pm 0.025 \text{ mm} \end{array}$
- 3. Dimensions nominal unless otherwise noted
- 4. Angles 45° nominal
- 5. Contact areas are gold plated
- 6. Metal Gnd and I/O pads are solder mask defined by means of a thin (< 1μm) oxide layer

Package Marking Code:

AVAGO = Avago Technologies, Inc.

W = ACFM-7037

I = Assembly Information

Y = Year

WW = Work Week

DD = Date Code

XXXX = Assembly Lot

SSSSS = Production Information

Pin Description

Pin	Connection
1	Band 7 Rx
4	Band 3 Rx
8	Band 3 Tx
11	Band 7 Tx
13	Ant
2, 3, 5, 6, 7, 9, 10, 12, 14, 15	GND

For product information and a complete list of distributors, please go to our web site: www.avagotech.com

Avago, Avago Technologies, and the A logo are trademarks of Avago Technologies in the United States and other countries. All other brand and product names may be trademarks of their respective companies.

Data subject to change. Copyright © 2015 Avago Technologies. All Rights Reserved.

AV02-4911EN - 2015-05-01



